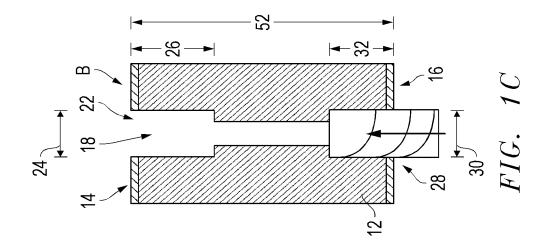
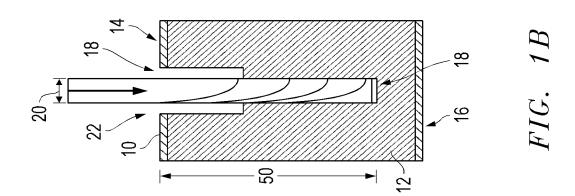
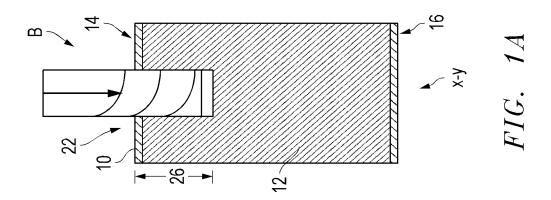
Title: CROSS CONNECT VIA FOR MULTILAYER PRINTED CIRCUIT BOARDS Inventor(s): Stephen J. Vetter; Thomas D. Murry; Randolph A. Latall;

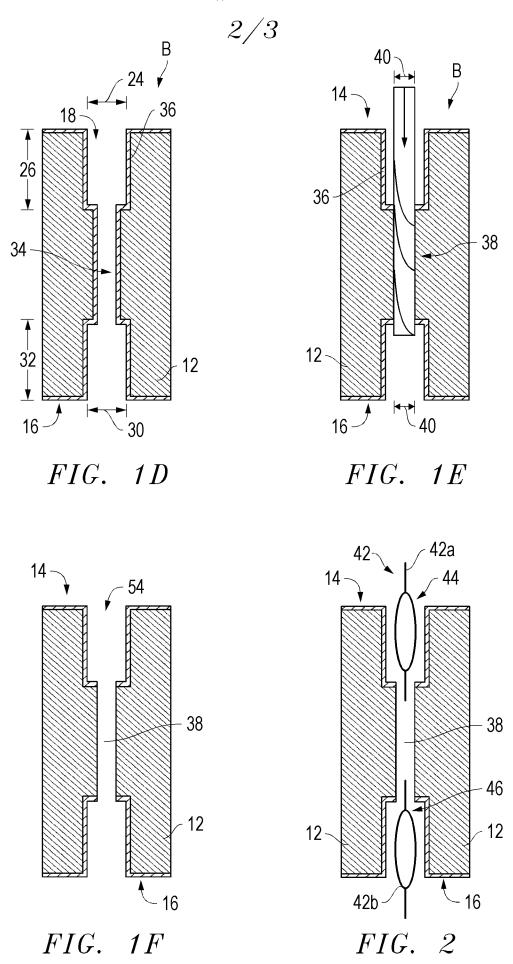
Sharon L. Cook; and, Eric W. Montgomery **Docket/Application No.:** 000210-206











Title: CROSS CONNECT VIA FOR MULTILAYER PRINTED CIRCUIT BOARDS Inventor(s): Stephen J. Vetter; Thomas D. Murry; Randolph A. Latall; Sharon L. Cook; and, Eric W. Montgomery Docket/Application No.: 000210-206



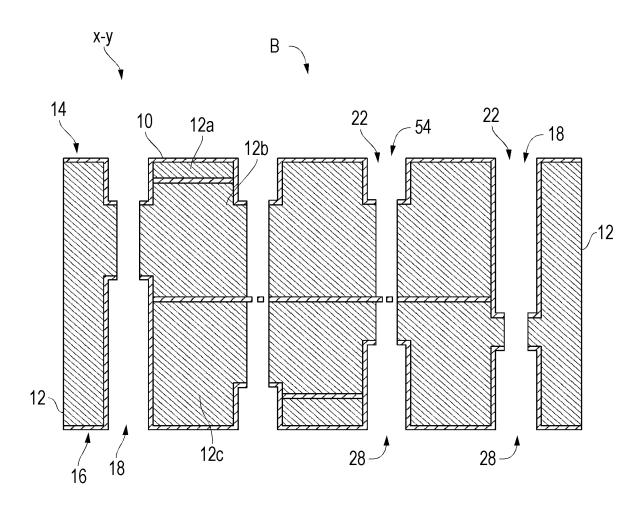


FIG. 3